



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Xiaodong R. Fu, et al.

Serial No: 10/676,863

Filed: September 30, 2003

For: HIGH POROSITY HONEYCOMB AND METHOD

Examiner: Gordon Baldwin

Group Art Unit: 1775

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §§ 1.56, 1.97 – 1.98Mail Stop Amendment
Commissioner of Patents
Alexandria, VA 22313-1450

Dear Sir:

The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application.

In addition to the prior art of record in this application, including the publications specifically mentioned in the application and/or listed in one or more forms PTO-1449 being submitted in this case, the Examiner's attention is also invited to the following document(s) consisting of one or more co-pending U.S. patent applications assigned to the assignee of the present application:

| Serial No. | Applicant(s) | Filing Date |
|------------|--------------|-------------|
| 11/432,038 | Miao | 5/10/2006 |
| 11/316,294 | Addiego | 12/21/2005 |

It is the position of the Applicant(s) that the claims of the present application cover only subject matter that is patentably distinct from these listed applications.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

Respectfully submitted,

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SP-TI-03-1
Corning, NY 14831
607-974-0463
Date: February 16, 2007

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Mail Stop Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 2/16/07

Date of Deposit

Randall S Wayland

Name of applicant, assignee, or
Registered Representative

Signature

2/16/07

Date of Signature

FORM PTO-1449 (MODIFIED)

ATTORNEY DOCKET NO.

SERIAL NO.

LIST OF PATENTS AND PUBLICATIONS
FOR APPLICANTS INFORMATION
DISCLOSURE STATEMENT

FEB 20 2007

SP03-127

10/676,863

APPLICANT Xiaodong R. Fu, et al.

FILING DATE

9/30/2003

GROUP:

1775

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

| Examiner Initial | | Document Number | Date | Name | Class | Sub-Class | Filing Date if Approp. |
|------------------|----|-----------------|----------|---------------|-------|-----------|------------------------|
| | AA | 6,432,856 | 8/13/02 | Beall et al. | 501 | 118 | |
| | AB | 2004/0152593 | 8/5/04 | Cutler et al. | 502 | 439 | |
| | AC | 6,159,893 | 12/12/00 | Kondo | 502 | 251 | |
| | AD | | | | | | |
| | AE | | | | | | |
| | AF | | | | | | |
| | AG | | | | | | |
| | AH | | | | | | |
| | AI | | | | | | |
| | AJ | | | | | | |
| | AK | | | | | | |

FOREIGN PATENT DOCUMENTS

| | | Document Number | Date | Country | Class | Sub-Class | Translation Yes | No |
|--|----|-----------------|------|---------|-------|-----------|-----------------|----|
| | AL | | | | | | | |
| | AM | | | | | | | |
| | AN | | | | | | | |
| | AO | | | | | | | |
| | AP | | | | | | | |
| | AQ | | | | | | | |

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

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| | AR | |
| | AS | |
| | AT | |
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| | AV | |
| | AW | |

EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.